TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

TC75S59F,TC75S59FU,TC75S59FE

Single Comparator

The TC75S59F/TC75S59FU/TC75S59FE is a CMOS general-purpose single comparator. The device can operate off a single power supply and draws a lower supply current than a conventional bipolar general-purpose comparator. This device's open-drain output stage can be wire-ORed with those of other open-drain output circuits.

Features

• Low-current power supply : $IDD = 100 \mu A \text{ (typ.)}$

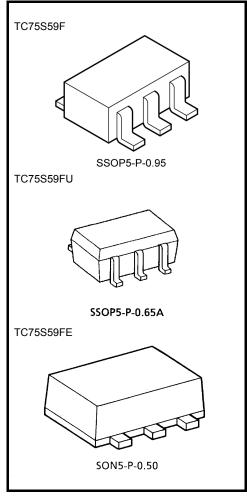
• Single power supply operation

• Wide common mode input voltage range: VSS~VDD - 0.9 V

· Open drain output circuit

Low input bias current

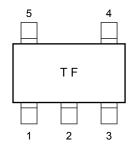
Small package



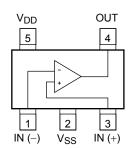
Weight

SSOP5-P-0.95 : 0.014 g (typ.) SSOP5-P-0.65A : 0.006 g (typ.) SON5-P-0.50 : 0.003 g (typ.)

Marking (top view)



Pin Connection (top view)



Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Supply voltage		V _{DD} , V _{SS}	±3.5 or 7	V	
Differential input voltage		DV _{IN}	±7	V	
Input voltage		V _{IN}	$V_{SS} \sim V_{DD}$	V	
Output current		Io	±35	mA	
Power dissipation	TC75S59F/FU	PD	200	mW	
	TC75S59FE	PD	100	IIIVV	
Operating tempera	ting temperature		-40~85	°C	
Storage temperature		T _{stg}	-55~125	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This device's CMOS structure makes it prone to latch-up. To prevent latch-up, please take the following precautions:

- Ensure that no I/O pin's voltage level ever exceeds V_{DD} or drops below V_{SS}.
 In addition, check the power-on timing.
- Do not subject the device to excessive noise.



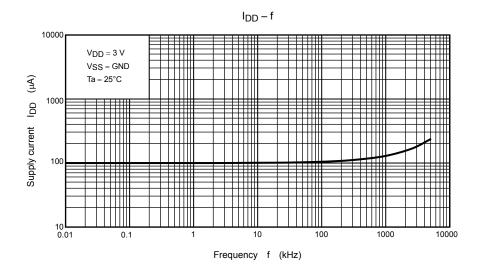
Electrical Characteristics ($V_{DD} = 5 V$, $V_{SS} = GND$, Ta = 25°C)

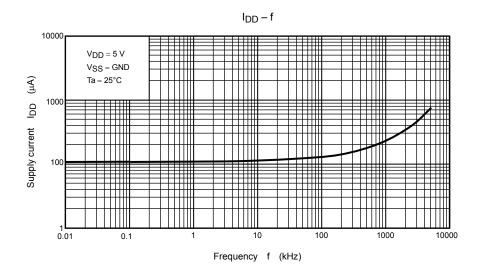
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	V _{IO}	_	_	_	±1	±7	mV
Input offset current	I _{IO}	_	_	_	1	_	pА
Input bias current	lı	_	_	_	1	_	pА
Common mode input voltage	CMV _{IN}	_	_	0	_	4.1	V
Supply current	I _{DD} (Note)	_	_	_	110	220	μА
Voltage gain	G _V	_	_	_	94	_	dB
Sink current	I _{sink}	_	V _{OL} = 0.5 V	13	25	_	mA
Output leak current	I _{LEAK}	_	V _O = 5 V	_	5	_	nA
Output voltage	V _{OL}	_	I _{sink} = 5.0 mA	_	0.1	0.3	V
Operating supply voltage	V _{DD}	_	_	1.8	_	7.0	V
Dranagation dalay time (turn on)	t _{PLH (1)}	_	Over drive = 100 mV	_	200	_	- ns
Propagation delay time (turn on)	t _{PLH} (2)	_	TTL step input	_	140	_	
Propagation delay time (turn off)	t _{PHL} (1)	_	Over drive = 100 mV	_	80	_	ns
	t _{PHL} (2)	_	TTL step input	_	60	_	
Posponso timo	t _{TLH}	_	Over drive = 100 mV	_	160	_	- ns
Response time	t _{THL}	_	Over drive = 100 mV		3		

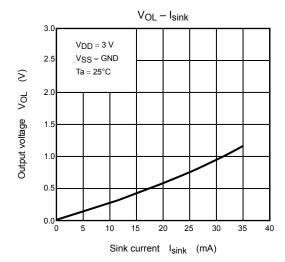
Electrical Characteristics (V_{DD} = 3 V, V_{SS} = GND, Ta = 25°C)

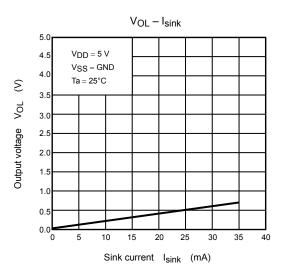
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	V _{IO}	_	_	_	±1	±7	mV
Input offset current	I _{IO}	_	_	_	1	_	pА
Input bias current	lį	_	_	_	1	_	pA
Common mode input voltage	CMV _{IN}	_	_	0	_	2.1	V
Supply current	I _{DD} (Note)	_	_	_	100	200	μА
Sink current	I _{sink}	_	V _{OL} = 0.5 V	6	18	_	mA
Output leak current	I _{LEAK}	_	V _O = 3 V	_	5	_	nA
Output voltage	V _{OL}	_	I _{sink} = 5.0 mA	_	0.15	0.35	V
Propagation delay time (turn on)	t _{PLH}	_	Over drive = 100 mV	_	160	_	ns
Propagation delay time (turn off)	t _{PHL}	_	Over drive = 100 mV	_	70	_	ns
Response time	t _{TLH}	_	Over drive = 100 mV	_	170	_	no
	t _{THL}	_	Over drive = 100 mV	_	3	_	ns

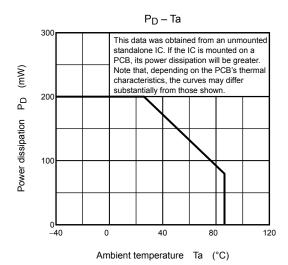
Note: This device's current consumption increases as its operating frequency increases. Note that the power dissipation should not exceed the allowable power dissipation.



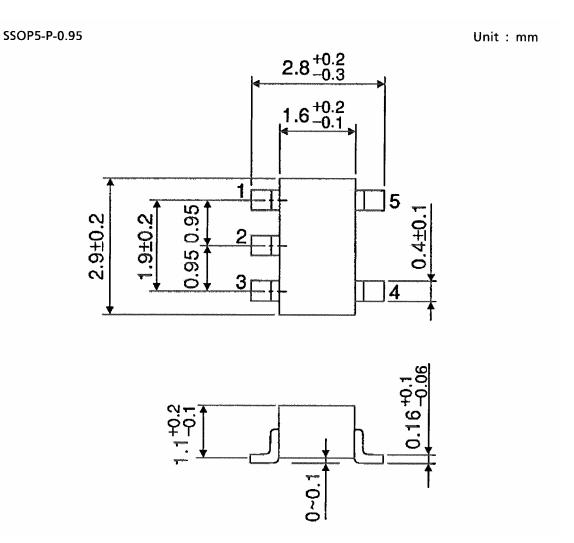








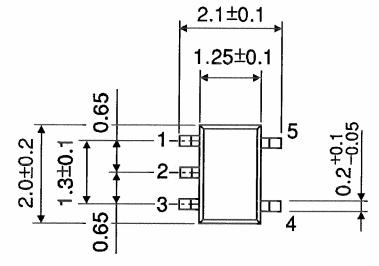
Package Dimensions

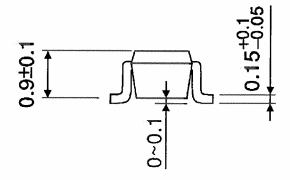


Weight: 0.014 g (typ.)

Package Dimensions

SSOP5-P-0.65A Unit: mm



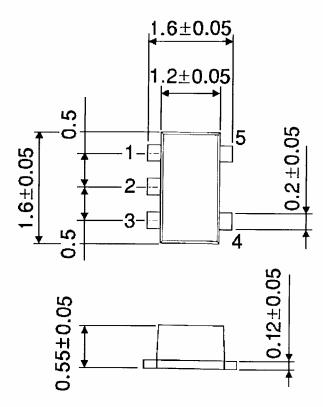


Weight: 0.006 g (typ.)



Package Dimensions

SON5-P-0.50 Unit: mm



Weight: 0.003 g (typ.)

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20070701-EN GENERAL

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